

Board Stack Report

Stack Up		Layer Stack							
Layer	Board Layer Stack	Name	Material	Thickness	Constant	Dk	Coverlay expansion	Orientation	Copper Orientation
1		Top Overlay		0mm					
2		Top Solder	Solder Resist	0.01016mm	3.5	3.5	0mm		
3		Top Layer		0.03556mm				BodyUp	Above
4		Dielectric 1	FR-4	0.32004mm	4.8	4.8			
5		Bottom Layer		0.03556mm				BodyDown	Below
6		Bottom Solder	Solder Resist	0.01016mm	3.5	3.5	0mm		
7		Bottom Overlay		0mm					
	Height : 0.41148mm								